



## Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC P	ARAMETERS				-	-	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_{D} = -250 \mu A, V_{GS} = 0 V$	/	-40			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -40V, V_{GS} = 0V$				-1	
		$T_J = 55^{\circ}C$				-5	μA
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$	1			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = -250 \mu A$		-1.7	-1.9	-2.5	V
I <sub>D(ON)</sub>	On state drain current	$V_{GS} = -10V, V_{DS} = -5V$	/	-120			А
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -10V, I_{D} = -10A$			12.5	15	
			T <sub>J</sub> =125°C		19	23	mΩ
		$V_{GS} = -4.5V, I_{D} = -8A$			16	20	
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5V, I_{D} = -10A$			25		S
$V_{SD}$	Diode Forward Voltage	$I_{\rm S} = -1A, V_{\rm GS} = 0V$			-0.7	-1	V
I <sub>S</sub>	Maximum Body-Diode Continuous Curr	ent				-3	А
DYNAMIC	PARAMETERS						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =-20V, f=1MHz			2500	3000	pF
C <sub>oss</sub>	Output Capacitance				260		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				180		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		2.5	4	6	Ω
SWITCHI	NG PARAMETERS						
Q <sub>g</sub> (10V)	Total Gate Charge	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V, I <sub>D</sub> =-10A			42	55	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge				18.6		nC
Q <sub>gs</sub>	Gate Source Charge				7		nC
$Q_{gd}$	Gate Drain Charge				8.6		nC
t <sub>D(on)</sub>	Turn-On DelayTime	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V, R <sub>L</sub> = 2Ω, R <sub>GEN</sub> =3Ω			9.4		ns
t <sub>r</sub>	Turn-On Rise Time				20		ns
t <sub>D(off)</sub>	Turn-Off DelayTime				55		ns
t <sub>f</sub>	Turn-Off Fall Time				30		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =-10A, dl/dt=100A/μs			38	49	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> =-10A, dI/dt=100A/μs			47		nC

A: The value of R<sub>BJA</sub> is measured with the device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> = 25°C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to lead R  $_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using t  $\leqslant$  300  $\mu s$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}$  C. The SOA curve provides a single pulse rating.

F. The current rating is based on the t  $\leqslant$  10s thermal resistance rating.

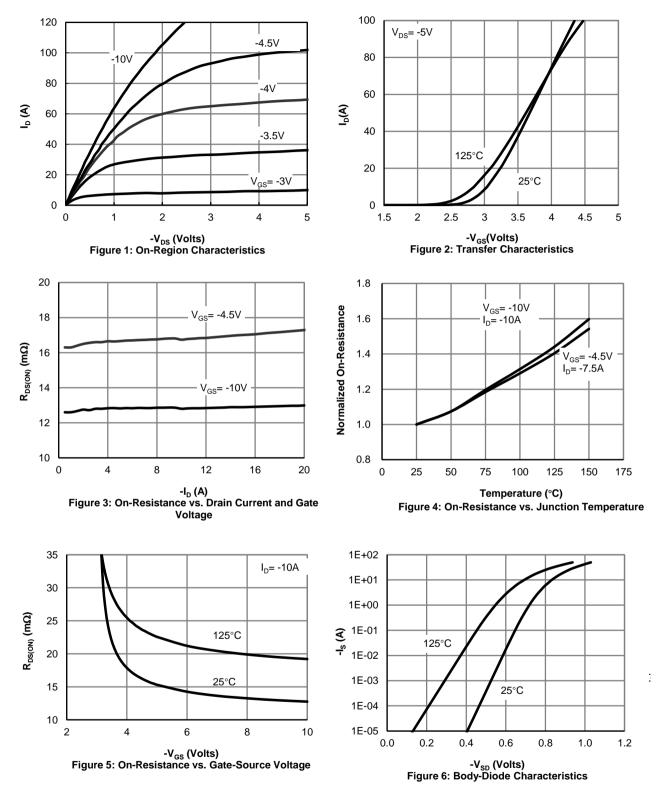
G. E<sub>AR</sub> and I<sub>AR</sub> ratings are based on low frequency and duty cycles to keep T<sub>i</sub>=25C.

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